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Farnell GmbH

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Rework Station

Rework of BGA, CSP and QFN

The rework stations facilitates the reliable and precise rework of BGA-, CSP-, and QFN-components, connectors and sockets. Innovative technologies such as “Advanced Vision Placement”, Hybrid Heating Technology and the intuitively operated “Easy Solder” software ensure safe soldering and de-soldering without the intervention of operators in the soldering process.

Rework of SMD USB-Socket on Mainboard

Rework of SMD USB-Socket on Mainboard

These compact rework stations are, in addition to soldering and de-soldering, suitable for removing residual solder and for dispensing fluxes and solder pastes. With the software “Easy Solder” all rework profiles are easily managed.

The EXPERT product family offers a comprehensive selection of Hybrid and IR Underheaters to ensure ideal conditions for the different rework applications. MARTIN offers different options and tools to get the best from the equipment in each application.

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